	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level p	arts, the	declaratio	n encor		er level mate	erials for	which t	e item is an assembly he manufacturer has declaration.		
1/32-2 1.1		Web Site for Informat		-1752 Standa	rd		Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, Homog					geneous Materials and Mfg Informat				
Supplier Information																
Company Name * Company Unique ID				Unique ID Au	Ithority	Response Date *				Response Doo	ument ID					
SEMTECH CORPORATION 00-		00-847-9941		DUNS	2013-07-09											
Contact Name * Roya Reader		Title - Contact QA Customer Servic	e Specialis	Phone - Cor 805-389-274	Email - Contact * rreader@semtech.com			I	Duplicate Contact -> Authorized Representative							
Authorized Representati Roya Reader	Title - Representative QA Customer Servic		-	resentative * 2	Email - Representative * rreader@semtech.com				Supplier Comr	nents or URL	for Add	litional li	nformation			
Requester Item Number	r	Mfr Item Number		Mfr Item Name	Effectiv	e Date	Version Manufa		cturing Site	Weight *	UO	M	Unit Type			
		EClamp2374P.TCT		ESD-EMI 4-li	ne Protection for C				China	5.249		mg		Each		
Alternate Recommenda	ation				Alternate Item C			mments				·				
Manufacturing Proces	ss In	formation								·						
Terminal Plating / Grid Array I	Materi	ial	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ting	Peak Proc	ess Body	Temper	ature Max Time	at Peak Tem	perature	Number	of Reflow Cycles		
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy				260 (30 se	conds	3					
EClamp2374P.TCT is RE	EACH	I-compliant product	, per EU R	egulation EC	1907/2006 to inc	lude re	cent add	lition of	SVHC o	candidate list	of substanc	es in Ju	ne 2013	3		

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields				
RoHS Material Composition Declaration Declaration Declaration Type * Detailed											
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),				
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided				
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted				
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration				
Declaration S	ignature										
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars				

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exempt	Woight	Unit of	Tolerance		РРМ
	Name		Material	weight	Measure		Level	Substance Category			Substance	CAS	Exempt	weight	Measure	-	+	FFIVI
+I -I	Die	+M -M	Doped Silicon	0.1685	mg	+C -	C Supplier		+S	-S	Si	7440-21-3		0.1685	mg		3	32,102
+I -I	Leadframe	+M -M	C7025	1.54791	mg	+C -	C Supplier		+S	-S	Cu	7440-50-8		1.4844	mg		2	282,80
		_							+S	-s	Si	7440-21-3		0.0112	mg		2	2,138
						+C -	Св	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.0495	mg		9	9,437
						+C -	C Supplier		+S	-s	Mg	7439-95-4		0.0027	mg		Ę	516
		+M -M	Ni/Pd/Au Plating	0.03969	mg	+C -	Св		+S	-s	Nickel	7440-02-0		0.0358	mg		(6,818
						+C -	C Supplier	middle plating	+S	-s	Pd	7440-05-3		0.0033	mg		e	620
						+C -	C Supplier	Outer plating	+S	-s	Au	7440-57-5		0.0006	mg		1	123
+1 -1	Bonding wire	+M -M	Gold wire	0.0908	mg	+C -	C Supplier		+S	-S	Au	7440-57-5		0.0908	mg		1	17,299
+ -	Molding compoun	d +M -M	EME-G770HCD	3.32157	3mg	+C -	C Supplier		+S	-s	Silica fused	60676-86-0		3.1057	mg		5	591,66
	-								+S	-s	Epoxy resin	Proprietary		0.0996	mg			18,984
									+S	-s	Phenol resin	Proprietary		0.0996	mg			18,984
									+S	-s	C	1333-86-4		0.0166	mg		;	3,164
+1 -1	Die attached epox	у +М -М	QMI519	0.08054	lmg	+C -	C Supplier		+S	-s	Ag	7440-22-4		0.0644	mg		1	12,275
		_							+S	-S	palladium compound	Proprietary		0.0001	mg		2	23
									+S	-s	2,6-Di-tert-butyl-p-cresc	128-37-0		0.000004	Img			1
									+S	-s	Hydroquinone	123-31-9		0.00000	Img		(0.01
									+S	-s	Acrylate	Proprietary		0.0128	mg		2	2,431
									+S	-s	Bismaleimide resin	Proprietary		0.0024	mg		4	460
									+S	-s	Polymer of polybutadie	Proprietary		0.0008	mg			153